DK13..FQ/W

FAST SWITCHING THYRISTOR

APPLICATIONS

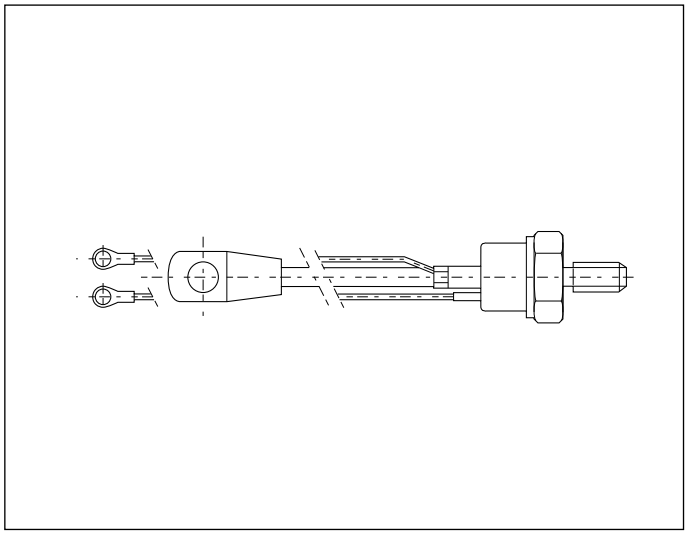
- High Power Inverters And Choppers.
- UPS.
- AC Motor Drives.
- Induction Heating.
- Cycloconverters.

KEY PARAMETERS

V_{DRM}	800V
$I_{T(RMS)}$	130A
I_{TSM}	1600A
dVdt	200V/µs
dI/dt	500A/µs
t_q	7-10µs

FEATURES

- Low Switching Losses At High Frequency.
- Fully Characterised For Operation Up To 20kHz.



Outline type code: TO94 See package outlines for further information.

VOLTAGE RATINGS

Type Number	Repetitive Peak Voltages V_{DRM} V_{RRM} V	Conditions
DK13 08FQ K or M DK13 06FQ K or M	800 600	$V_{RSM} = V_{RRM} + 100V$ $I_{DRM} = I_{RRM} = 15mA$ at V_{RRM} or V_{DRM} & T_{vj}

Q = t_q 7µs. e.g. DK13 08FQK.
W = t_q 10µs. e.g. DK13 08FWK.
For 1/2" 20 UNF thread add K to type number, e.g. DK13 06FWK.
For M12 thread add M to type number, e.g. DK13 06FQM.

CURRENT RATINGS

Symbol	Parameter	Conditions	Max.	Units
$I_{T(AV)}$	Mean on-state current	Half wave resistive load, T_{case} = 80°C	83	A
$I_{T(RMS)}$	RMS value	T_{case} = 80°C	130	A

SURGE RATINGS

Symbol	Parameter	Conditions	Max.	Units
I_{TSM}	Surge (non-repetitive) on-state current	t_p = 10ms half sine; T_{case} = 125°C	1.6	kA
I^2t	I^2t for fusing	V_R = 0% V_{RRM} - 1/4 sine	12.8×10^3	A^2s

THERMAL AND MECHANICAL DATA

Symbol	Parameter	Conditions	Min.	Max.	Units
$R_{th(j-c)}$	Thermal resistance - junction to case	dc	-	0.25	°C/W
$R_{th(c-h)}$	Thermal resistance - case to heatsink	Mounting torque 15.0Nm with mounting compound	-	0.08	°C/W
T_{vj}	Virtual junction temperature	On-state (conducting)	-	125	°C
		Reverse (blocking)	-	125	°C
T_{stg}	Storage temperature range		-40	150	°C
-	Mounting torque		12.0	15.0	Nm

DYNAMIC CHARACTERISTICS

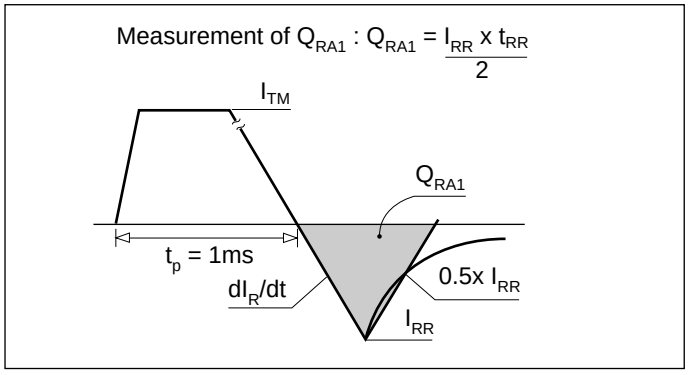
Symbol	Parameter	Conditions		Min.	Max.	Units
V_{TM}	Maximum on-state voltage	At 300A peak, T_{case} = 25°C		-	2.35	V
I_{RRM}/I_{DRM}	Peak reverse and off-state current	At V_{RRM}/V_{DRM}, T_{case} = 125°C		-	15	mA
dV/dt	Maximum linear rate of rise of off-state voltage	Linear to 60% V_{DRM} T_j = 125°C, Gate open circuit		-	200	V/µs
dI/dt	Rate of rise of on-state current	Gate source 20V, 20Ω t_r < 0.5µs, T_j = 125°C	Repetitive 50Hz	-	500	A/µs
			Non-repetitive	-	800	A/µs
$V_{T(TO)}$	Threshold voltage	At T_{vj} = 125°C		-	1.5	V
r_T	On-state slope resistance	At T_{vj} = 125°C		-	2.83	mΩ
t_{gd}	Delay time	T_j = 25°C, I_T = 50A, V_D = 300V, I_G = 1A, dI/dt =50A/µs, dI_G/dt = 1A/µs		1.5	-	µs
$t_{(ON)TOT}$	Total turn-on time			3	-	µs
I_H	Holding current	T_j = 25°C, I_{TM} = 1A, V_D = 12V		60*	-	mA
t_q	Turn-off time	T_j = 125°C, I_T = 100A, V_R = 50V, dV/dt = 200V/µs (Linear to 60% V_{DRM}), dI_R/dt = 30A/µs, Gate open circuit	t_q code: Q	-	7	µs
			t_q code: W	-	10	µs

**Typical value.*

GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Conditions	Typ.	Max.	Units
V_{GT}	Gate trigger voltage	V_{DRM} = 12V, T_{case} = 25°C, R_L = 6Ω	-	3.0	V
I_{GT}	Gate trigger current	V_{DRM} = 12V, T_{case} = 25°C, R_L = 6Ω	-	200	mA
V_{GD}	Gate non-trigger voltage	At V_{DRM} T_{case} = 125°C, R_L = 1kΩ	-	0.2	V
V_{RGM}	Peak reverse gate voltage		-	5.0	V
I_{FGM}	Peak forward gate current	Anode positive with respect to cathode	-	4	A
P_{GM}	Peak gate power		-	16	W
$P_{G(AV)}$	Mean gate power		-	3.0	W

MEASUREMENT OF RECOVERED CHARGE - Q_{RA1}



CURVES

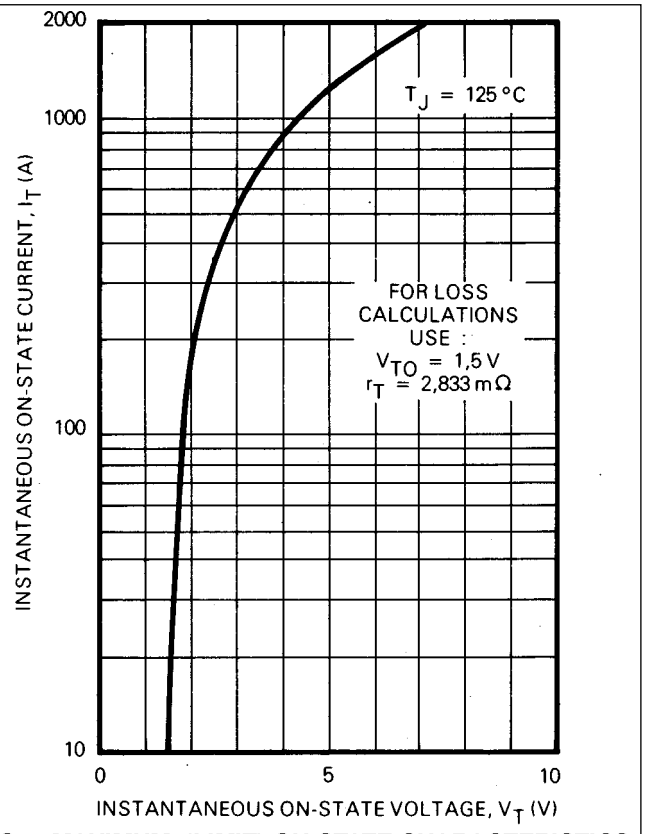


FIG. 1 MAXIMUM (LIMIT) ON-STATE CHARACTERISTICS

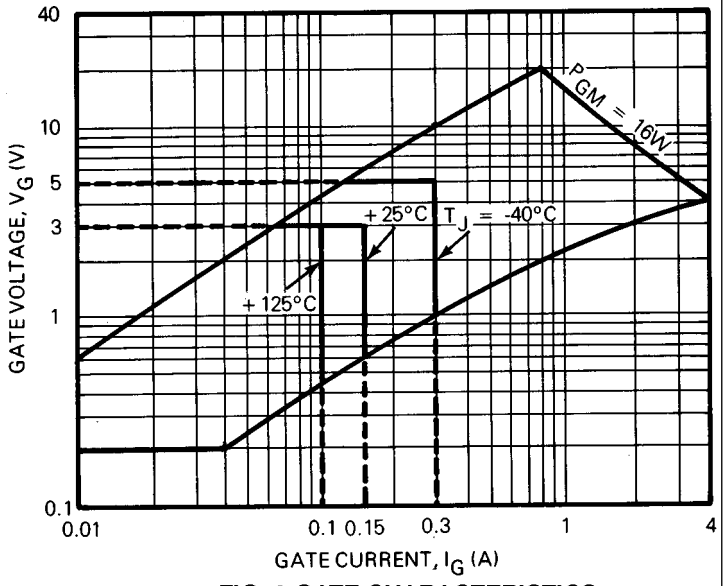


FIG. 2 GATE CHARACTERISTICS

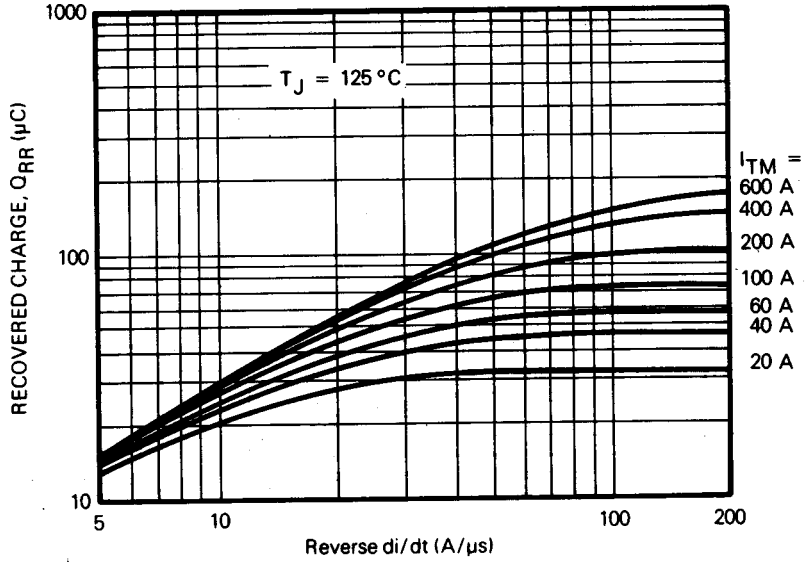


FIG. 3 TYPICAL RECOVERED CHARGE
(FOR A DEVICE RATED Vdrm = 600V, tq = 10µs)

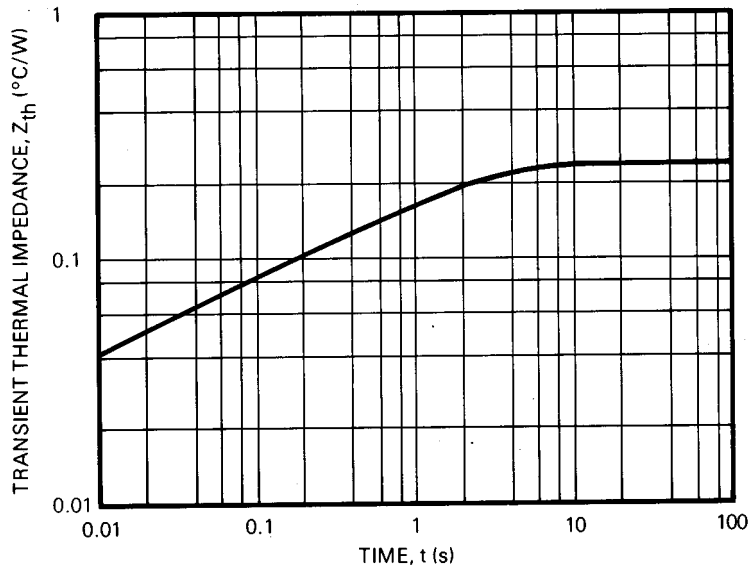


FIG. 4 TRANSIENT THERMAL IMPEDANCE - JUNCTION TO CASE

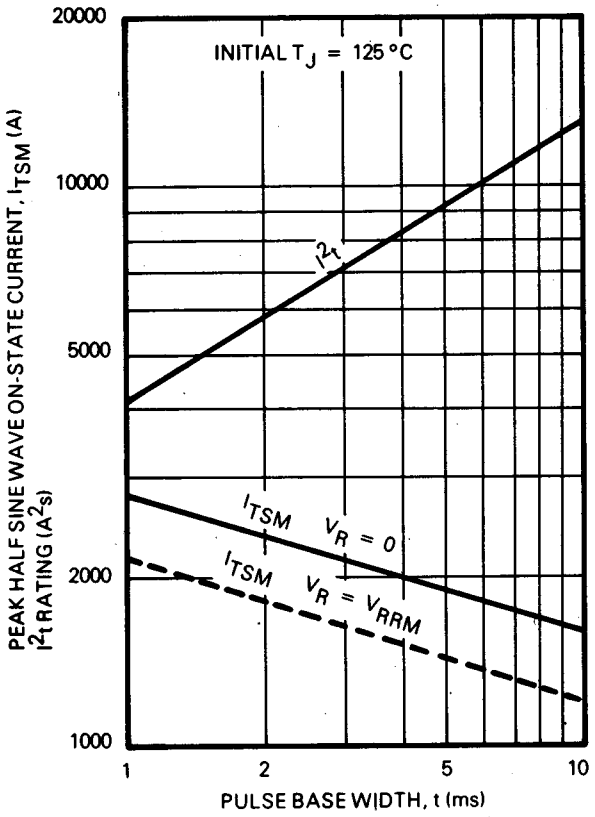


FIG. 5 NON-REPETITIVE SUB-CYCLE SURGE ON-STATE CURRENT AND I2t RATING

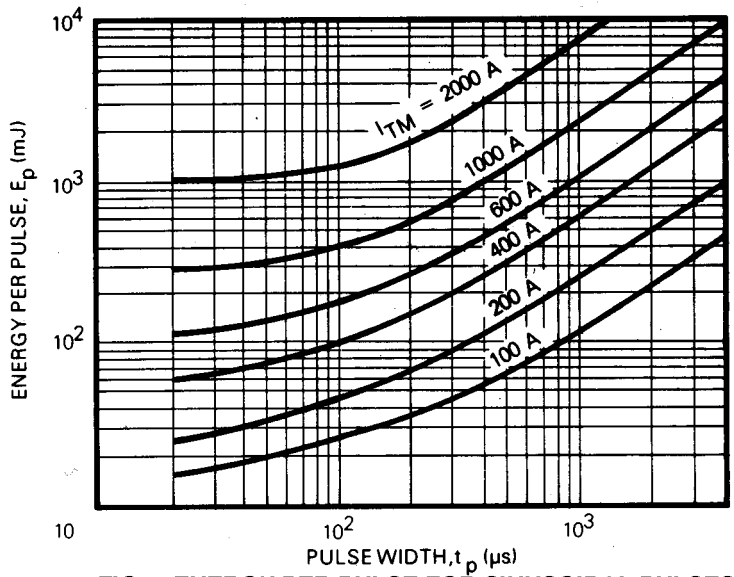
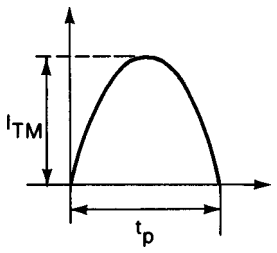


FIG. 6 ENERGY PER PULSE FOR SINUSOIDAL PULSES

NOTES:
1. $V_D \leq 600V$.
2. $V_R \leq 10V$.
3. R.C Snubber, C = 0.22µF, R = 4.7Ω



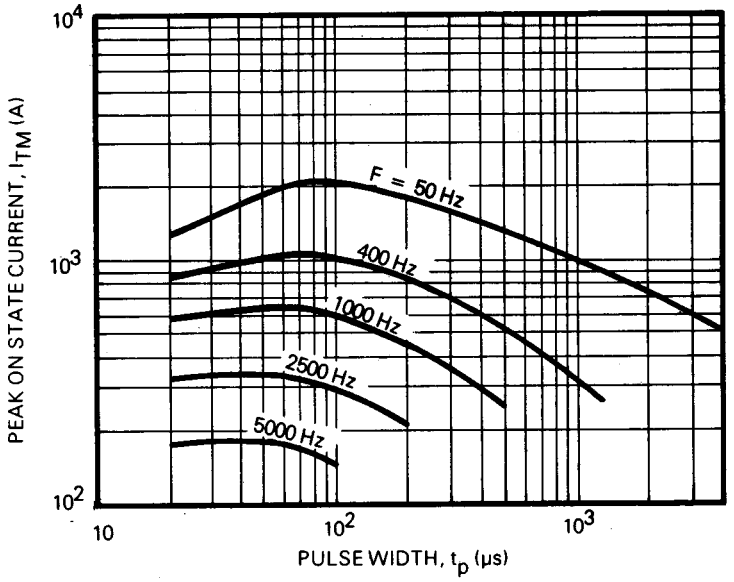
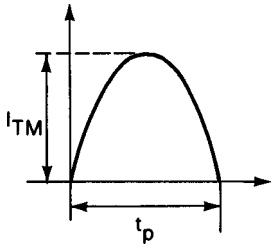


FIG. 7 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65˚C

NOTES:
1. $V_D \leq 600V$.
2. $V_R \leq 10V$.
3. R.C Snubber, C = 0.22µF, R = 4.7Ω



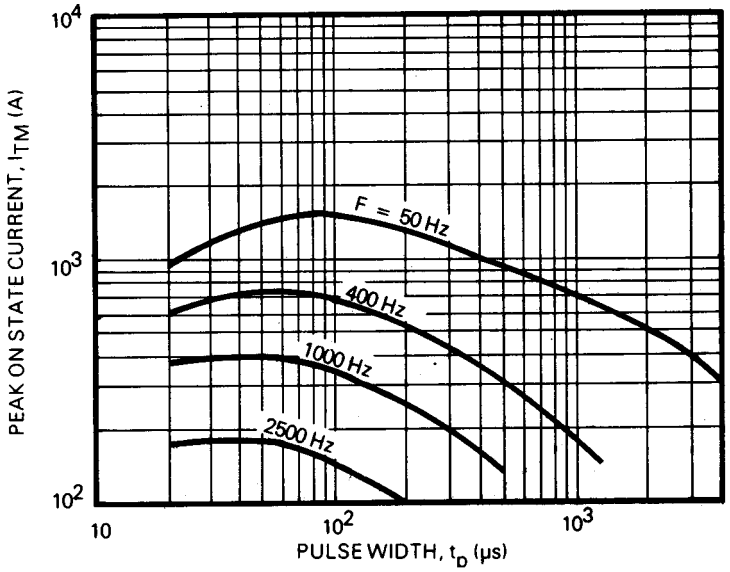
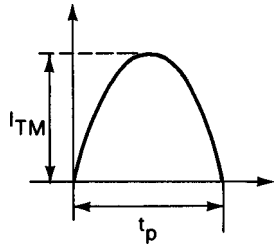


FIG. 8 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WITDTH FOR Tc = 90˚C

NOTES:
1. $V_D \leq 600V$.
2. $V_R \leq 10V$.
3. R.C Snubber, C = 0.22µF, R = 4.7Ω



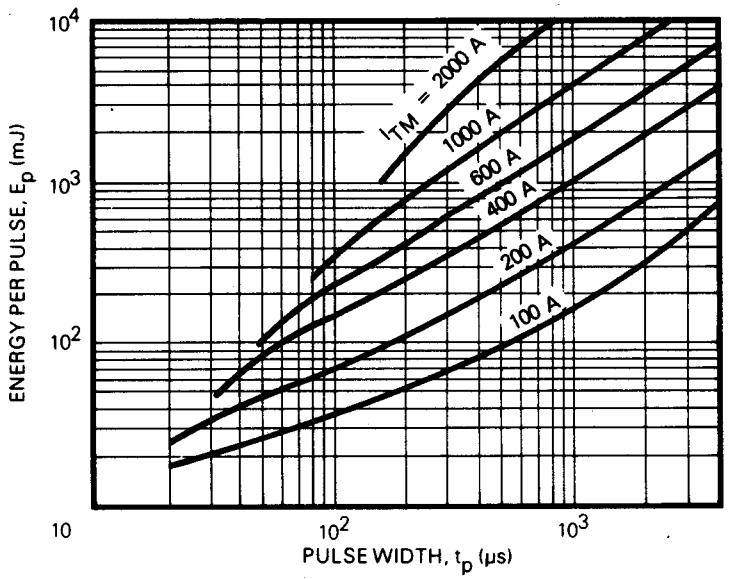
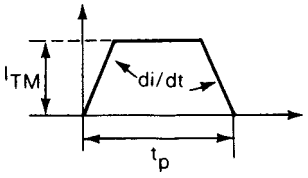


FIG. 9 ENERGY PER PULSE FOR TRAPEZOIDAL PULSES

NOTES:
1. dI/dt = 25A/µs
2. $V_D \leq 600V$.
3. $V_R \leq 10V$.
4. R.C Snubber, C = 0.22µF, R = 4.7Ω



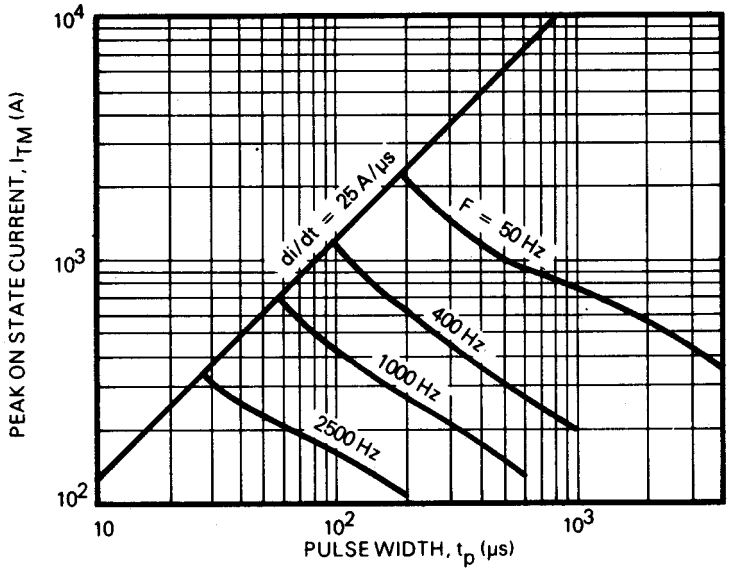
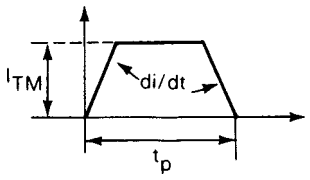


FIG. 10 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65˚C

NOTES:
1. dI/dt = 25A/µs
2. $V_D \leq 600V$.
3. $V_R \leq 10V$.
4. R.C Snubber, C = 0.22µF, R = 4.7Ω



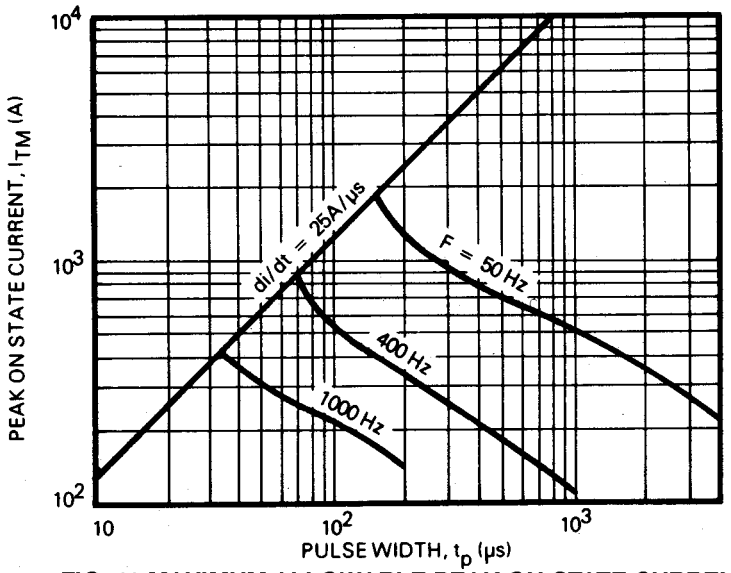
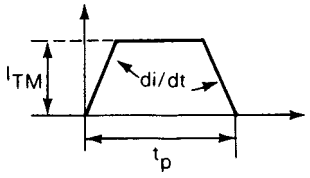


FIG. 11 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 90˚C

NOTES:
1. dI/dt = 25A/µs
2. $V_D \leq 600V$.
3. $V_R \leq 10V$.
4. R.C Snubber, C = 0.22µF, R = 4.7Ω



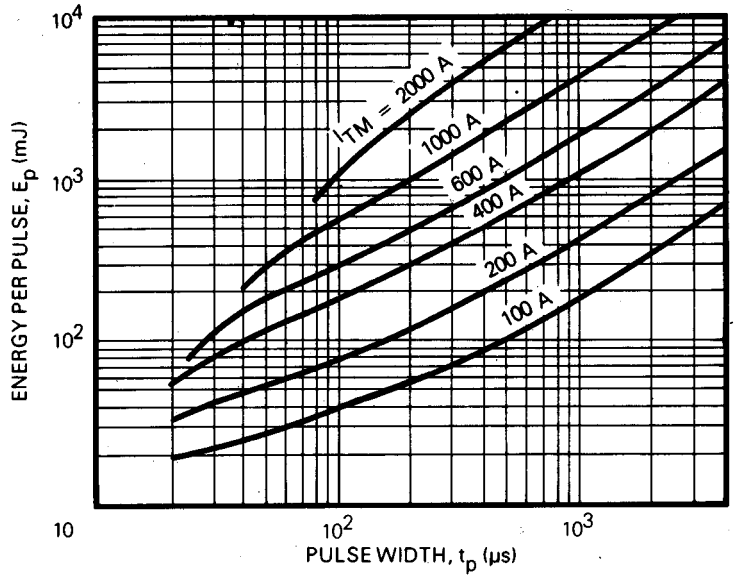
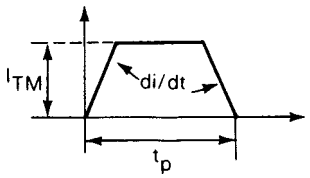


FIG. 12 ENERGY PER PULSE FOR TRAPEZOIDAL PULSES

NOTES:
1. dI/dt = 50A/µs
2. $V_D \leq 600V$.
3. $V_R \leq 10V$.
4. R.C Snubber, C = 0.22µF, R = 4.7Ω



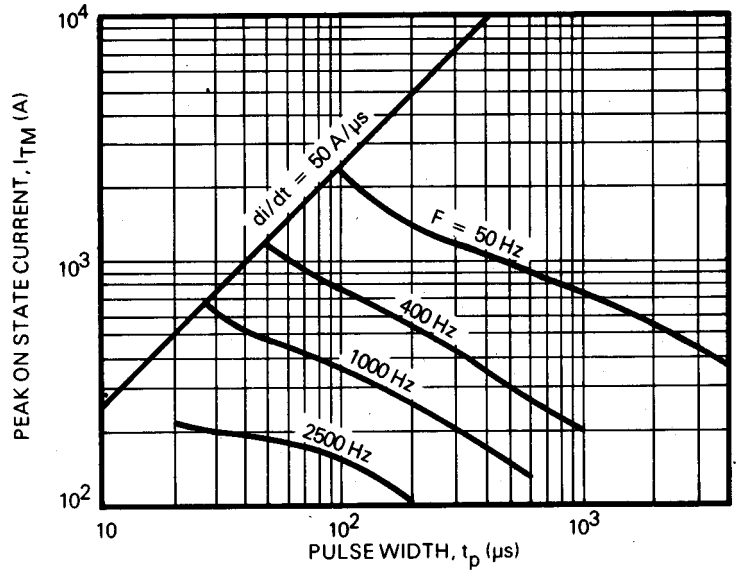
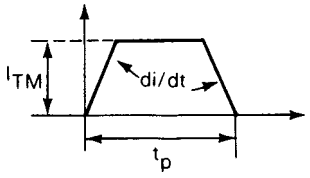


FIG. 13 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65°C

NOTES:
1. dI/dt = 50A/µs
2. $V_D \leq 600V$.
3. $V_R \leq 10V$.
4. R.C Snubber, C = 0.22µF, R = 4.7Ω



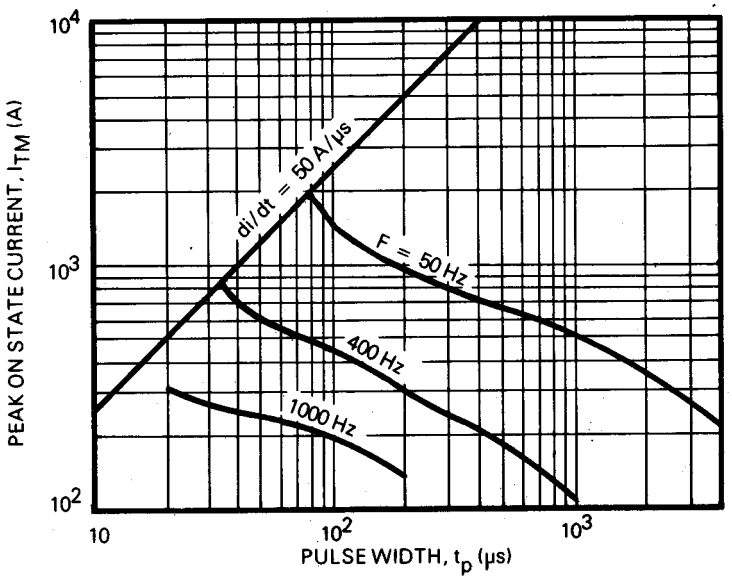
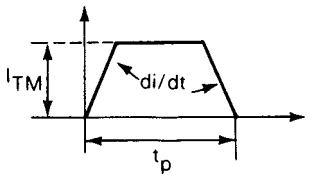


FIG. 14 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65˚C

NOTES:
1. dI/dt = 50A/µs
2. $V_D \leq 600V$.
3. $V_R \leq 10V$.
4. R.C Snubber, C = 0.22µF, R = 4.7Ω



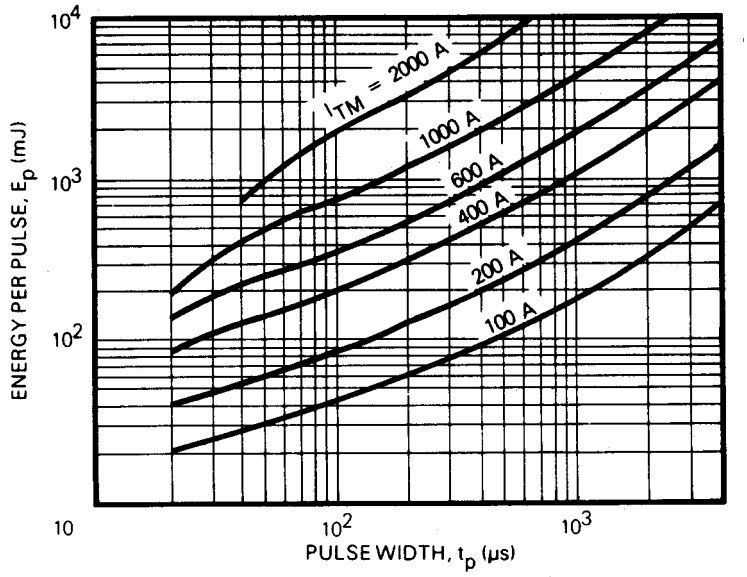
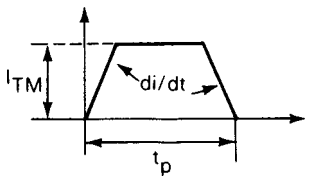


FIG. 15 ENERGY PER PULSE FOR TRAPEZOIDAL PULSES

NOTES:
1. dI/dt = 100A/µs
2. $V_D \leq 600V$.
3. $V_R \leq 10V$.
4. R.C Snubber, C = 0.22µF, R = 4.7Ω



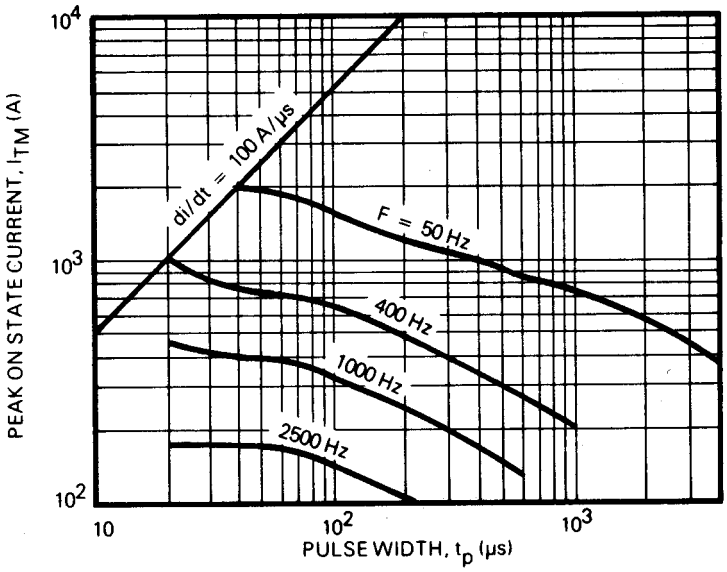
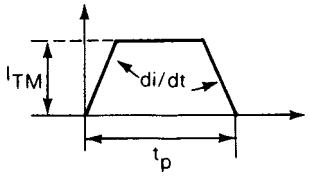


FIG. 16 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65˚C

NOTES:
1. dI/dt = 100A/µs
2. $V_D \leq 600V$.
3. $V_R \leq 10V$.
4. R.C Snubber, C = 0.22µF, R = 4.7Ω



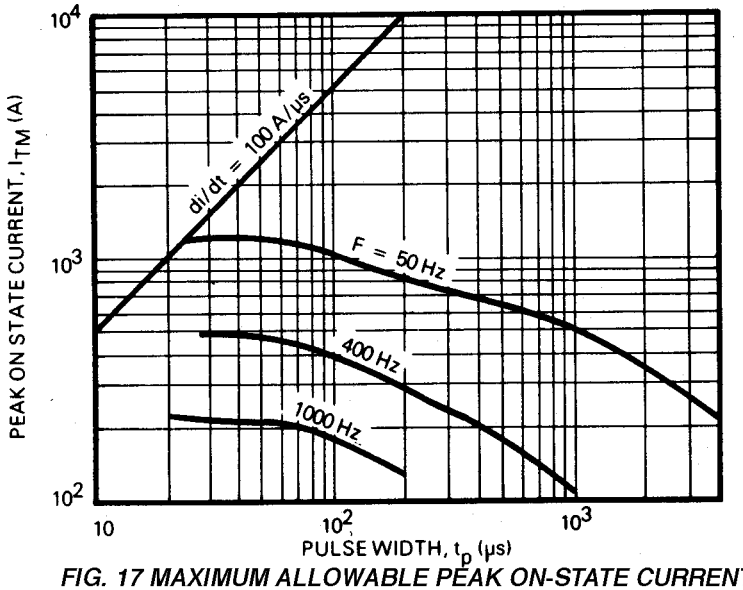
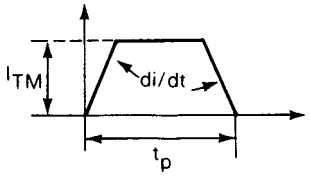


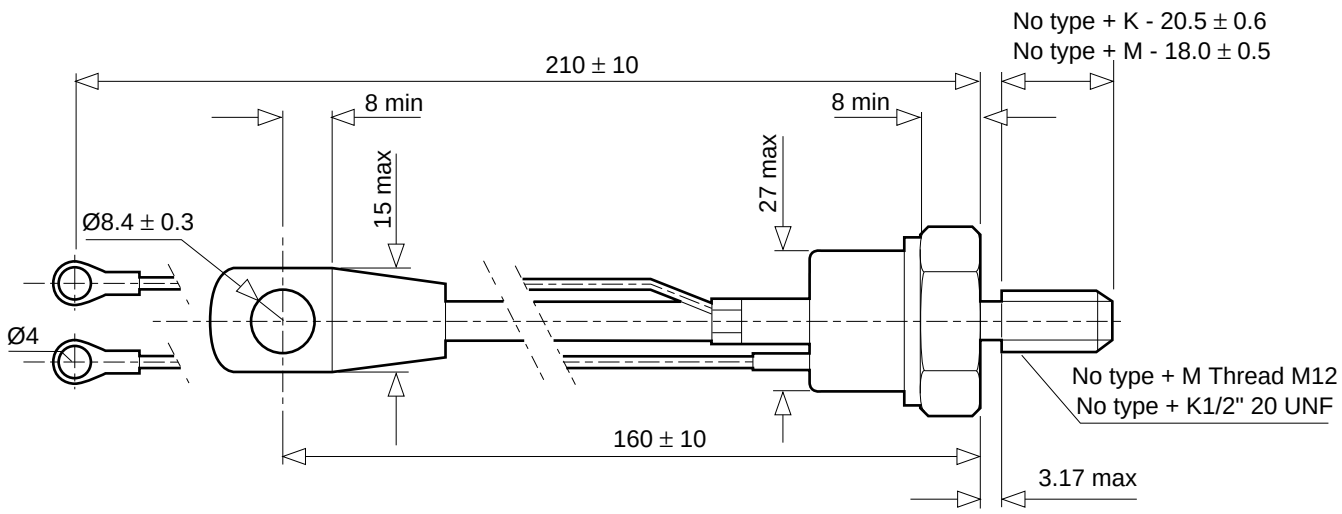
FIG. 17 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 90˚C

NOTES:
1. dI/dt = 100A/µs
2. $V_D \leq 600V$.
3. $V_R \leq 10V$.
4. R.C Snubber, C = 0.22µF, R = 4.7Ω



PACKAGE DETAILS - TO94

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



Weight: 120g

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